



CE65H270TOBI

CoreGaN 650V GaN HEMT

Description

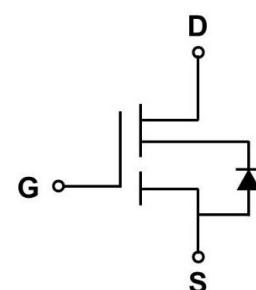
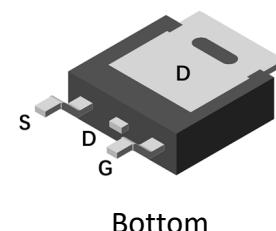
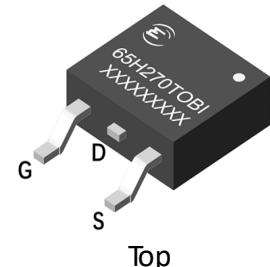
The CE65H270TOBI Series 650V, 270mΩ gallium nitride (GaN) FETs are normally-off devices.

Coreenergy GaN FETs offer better efficiency through lower gate charge, faster switching speeds, and lower dynamic on-resistance, delivering significant advantages over traditional silicon (Si) devices.

Coreenergy is a leading-edge wide band gap supplier with world-class innovation .

Ordering Information

Part Number	Package	Package Configuration
CE65H270TOBI	TO252	Drain



Circuit Symbol

Application

- Adapter
- Renewable energy
- Telecom and data-com
- Servo motors
- Industrial
- Automotive

General Features

- Easy to drive—compatible with standard gate drivers
- Low conduction and switching losses
- RoHS compliant and Halogen-free

Features

BV_{DSS}	$R_{DS(on)}$	I_{DS}	Q_G
650V	270mΩ	9.8A	8.7nC

- Increased efficiency through fast switching
- Increased power density
- Reduced system size and weight



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Absolute Maximum Ratings

$T_c=25^\circ\text{C}$ unless otherwise stated

Symbol	Parameter	Limit value	Unit
V_{DSS}	Drain to source voltage ($T_j = -55^\circ\text{C}$ to 150°C)	650	
$V_{(TR)DSS}$	Drain to source voltage-transient ^a	800	V
V_{GSS}	Gate to source voltage	-20~+20	
I_D	Continuous drain current @ $T_c=25^\circ\text{C}$ ^b	9.8	A
	Continuous drain current @ $T_c=125^\circ\text{C}$	4.6	
I_{DM}	Pulse drain current (pulse width: 10μs)	15	A
P_D	Maximum power dissipation @ $T_c=25^\circ\text{C}$	62	W
T_c	Operating temperature	Case	$-55\text{~}150$
T_j		Junction	$-55\text{~}150$
T_s	Storage temperature	-55~150	°C

a. In off-state, spike duty cycle $D<0.01$, spike duration <1μs

b. For increased stability at high current operation



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Thermal Resistance

Symbol	Parameter	Limit value	Unit
R_{\thetaJC}	Junction-to-case	2	°C /W



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Electrical Parameters

$T_J=25^\circ\text{C}$ unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
Forward Device Characteristics						
$V_{(\text{BL})\text{DSS}}$	Drain-source voltage	650	-	-	V	$V_{GS}=0\text{V}$
$V_{GS(\text{th})}$	Gate threshold voltage	3.3	3.9	4.5	V	
$\Delta V_{GS(\text{th})}/T_J$	Gate threshold voltage temperature coefficient	-	-7	-	mV/°C	$V_{DS}=1\text{V}, I_{DS}=1\text{mA}$
$R_{DS(\text{on})}$	Drain-source on-Resistance	-	270	320	mΩ	$V_{GS}=10\text{V}, I_D=1\text{A}, T_J=25^\circ\text{C}$
		-	570	-		$V_{GS}=10\text{V}, I_D=1\text{A}, T_J=150^\circ\text{C}$
I_{DSS}	Drain-to-source leakage current	-	1	10	μA	$V_{DS}=650\text{V}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$
		-	5	100		$V_{DS}=650\text{V}, V_{GS}=0\text{V}, T_J=150^\circ\text{C}$
I_{GSS}	Gate-to-source forward leakage current	-	-	±100	nA	$V_{GS}=\pm 20\text{V}$
C_{ISS}	Input capacitance	-	333	-		
C_{OSS}	Output capacitance	-	18	-	pF	$V_{GS}=0\text{V}, V_{DS}=400\text{V}, f=1\text{MHz}$
C_{RSS}	Reverse capacitance	-	3.7	-		
Q_G	Total gate charge	-	8.7	-		
Q_{GS}	Gate-source charge	-	2.2	-	nC	$V_{DS}=400\text{V}, V_{GS}=0\text{V to } 10\text{V}, I_D=1\text{A}$
Q_{GD}	Gate-drain charge	-	2.6	-		
Q_{OSS}	Output charge	-	24	-	nC	$V_{GS}=0\text{V}, V_{DS}=0\text{V to } 400\text{V}, f=1\text{MHz}$
$t_{D(\text{on})}$	Turn-on delay	-	3.2	-		
t_R	Rise time	-	5.5	-		
$t_{D(\text{off})}$	Turn-off delay	-	7.4	-	ns	$V_{DS}=400\text{V}, V_{GS}=0\text{V to } 10\text{V}, I_D=2.1\text{A}, R_{G-on(ext)}=6.8\Omega, R_{G-off(ext)}=2.2\Omega, L=250\mu\text{H}$
t_F	Fall time	-	27	-		



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Electrical Parameters

$T_j=25^\circ\text{C}$ unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
Reverse Device Characteristics						
V_{SD}	Source-Drain reverse voltage	-	2.3	-	V	$V_{GS}=0\text{V}$, $I_{SD}=5\text{A}$
t_{RR}	Reverse recovery time	-	14	-	ns	
Q_{RR}	Reverse recovery charge	-	6.5	-	nC	$I_F=5\text{A}$, $V_{DD}=400\text{V}$, $dI_F/dt=165\text{A}/\mu\text{s}$

Typical Characteristics

$T_j=25^\circ\text{C}$ unless otherwise stated

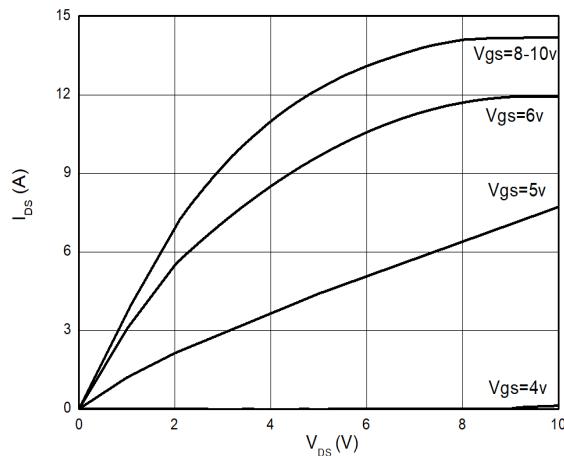


Figure 1. Typical Output Characteristics $T_j=25^\circ\text{C}$

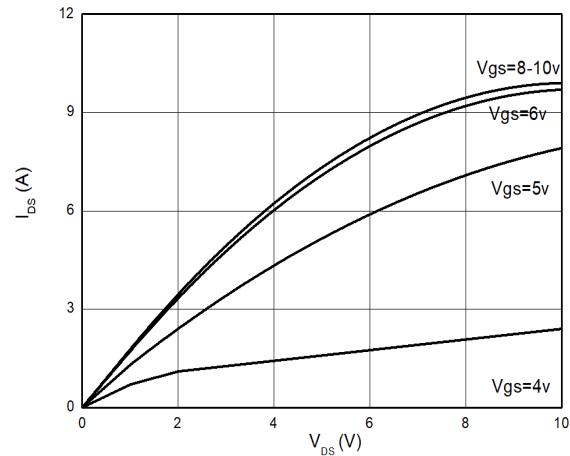


Figure 2. Typical Output Characteristics $T_j=125^\circ\text{C}$

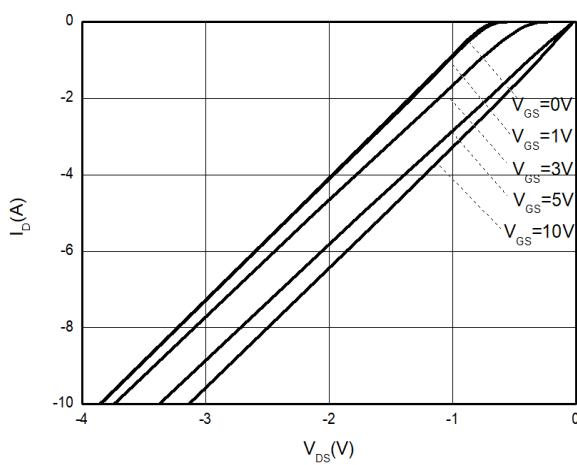


Figure 3. Channel Reverse Characteristics $T_j=25^\circ\text{C}$

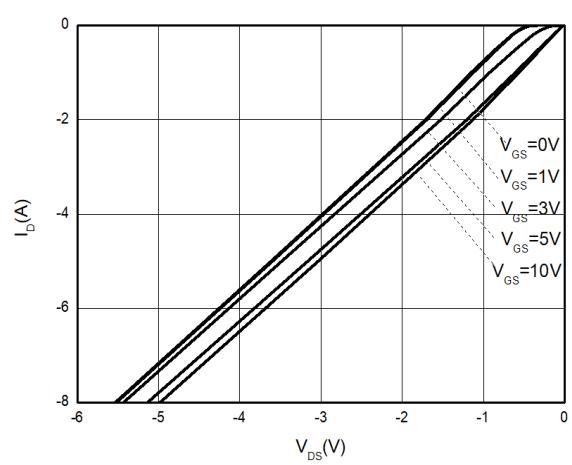


Figure 4. Channel Reverse Characteristics $T_j=125^\circ\text{C}$



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Typical Characteristics

$T_j=25^\circ\text{C}$ unless otherwise stated

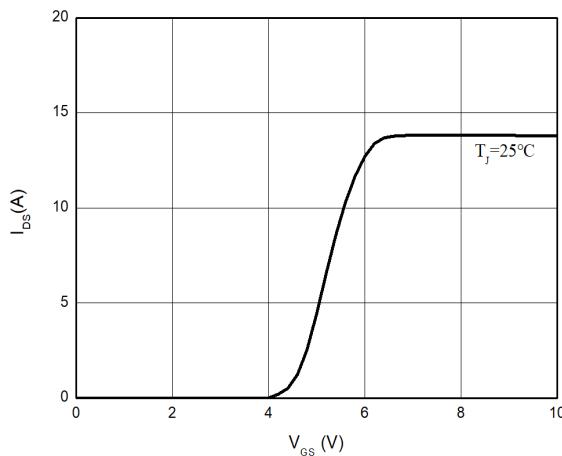


Figure 5. Typical Transfer Characteristics ($V_{DS}=10\text{V}$)

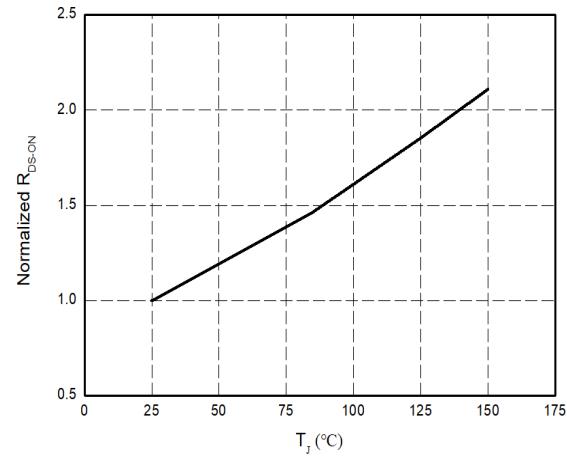


Figure 6. Normalized On-resistance

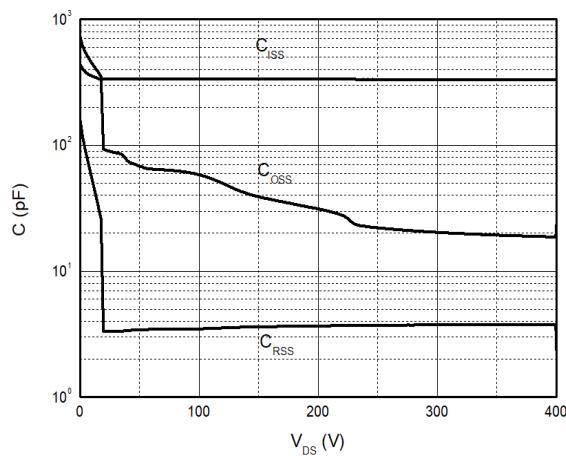


Figure 7. Typical Capacitance ($f=1\text{MHz}$)

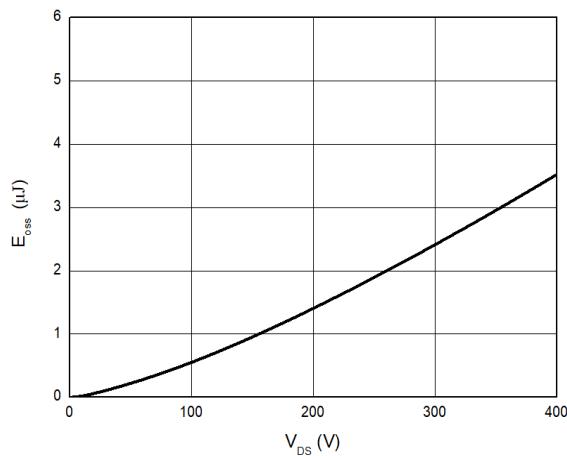


Figure 8. Typical C_{ooss} Stored Energy

Typical Characteristics

$T_j=25^\circ\text{C}$ unless otherwise stated

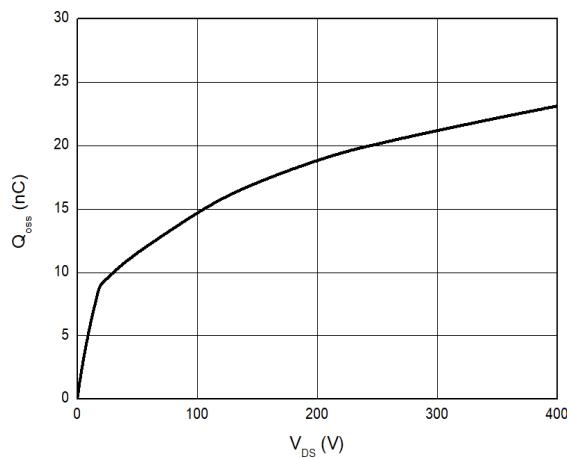


Figure 9. Typical Q_{oss}

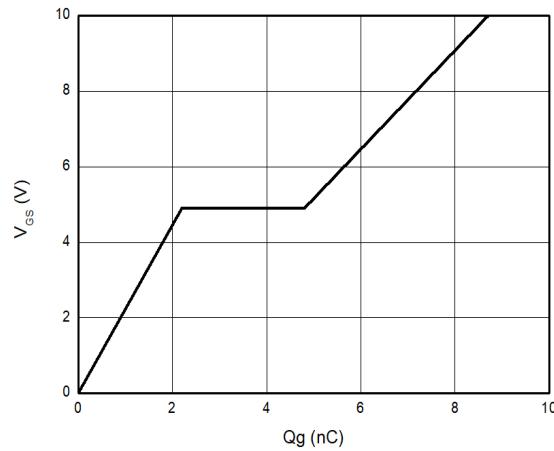


Figure 10. Typical Gate Charge ($V_{DS}=400\text{V}$, $I_D=1\text{A}$)

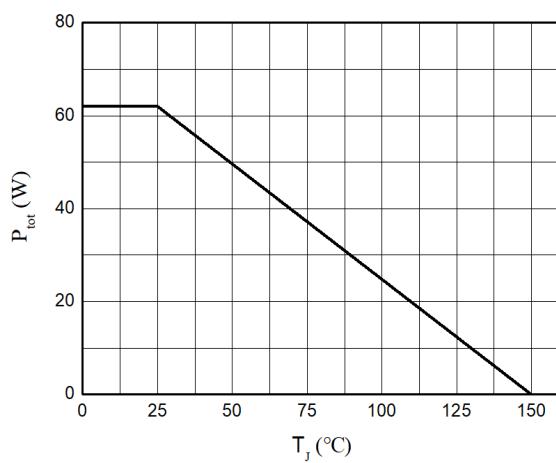


Figure 11. Power Dissipation

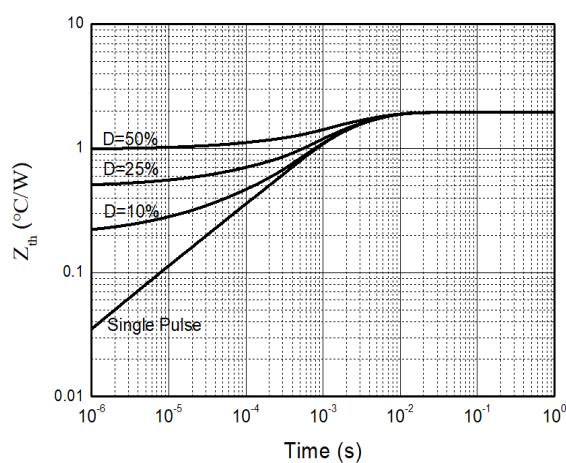


Figure 12. Transient Thermal Resistance

Typical Characteristics

$T_j=25^\circ\text{C}$ unless otherwise stated

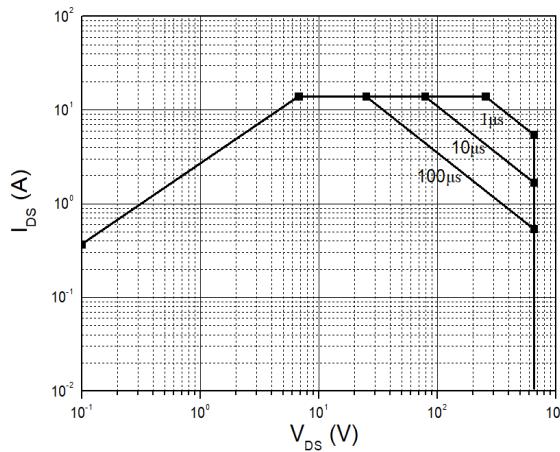


Figure 13. Safe Operating Area $T_c=25^\circ\text{C}$

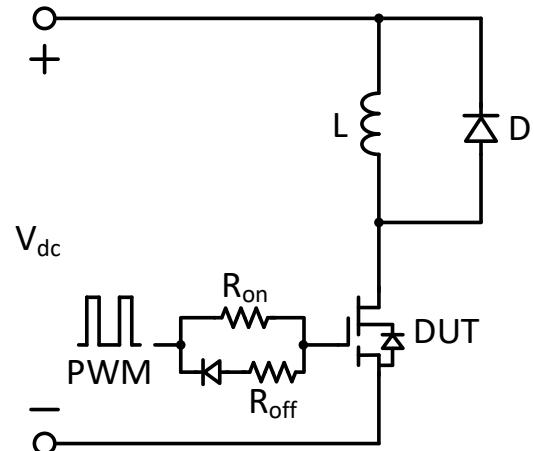


Figure 14. Switching times with inductive load

$V_{DS}=400\text{V}$, $V_{GS}=0\text{V}$ to 10V , $I_D=2.1\text{A}$,
 $R_{G-on(ext)}=6.8\Omega$, $R_{G-off(ext)}=2.2\Omega$, $L=250\mu\text{H}$

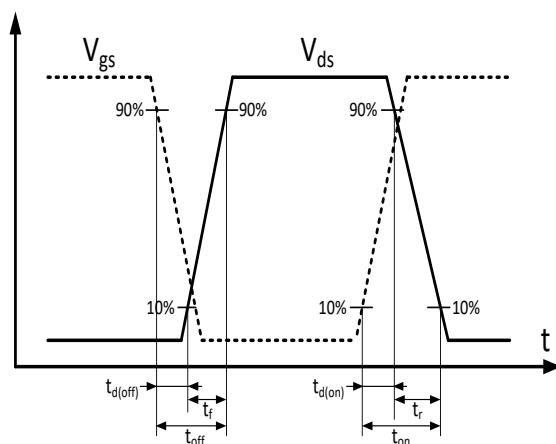


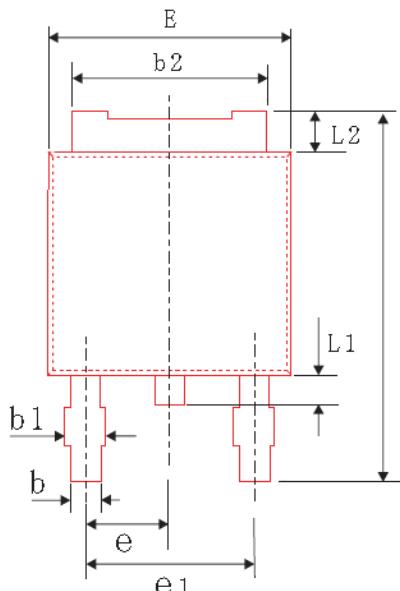
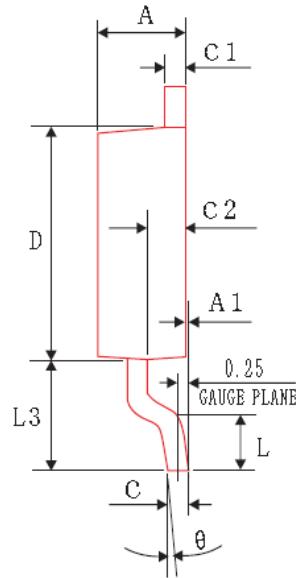
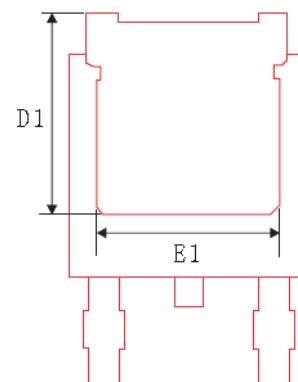
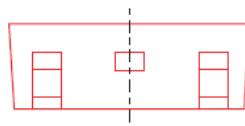
Figure 15. Switching times with waveform



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PACKAGE DIMENSIONS

TO252-2L

TOP VIEWSIDE VIEWBOTTOM VIEWSIDE VIEWCOMMON DIMENSIONS
(UNITS OF MEASURE-mm)

SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	0.05	0.10
b	0.762	0.812	0.862
b1	—	—	1.10
b2	5.23	5.33	5.43
c	0.458	0.508	0.558
C1	0.458	0.508	0.558
C2	0.80	1.00	1.20
D	6.00	6.10	6.20
D1	5.25	5.45	5.65
H	10.00	10.10	10.20
E	6.50	6.60	6.70
E1	4.75	4.85	4.95
e1	4.37	4.57	4.77
L	—	—	1.45
L1	0.60	0.75	0.90
L2	0.90	1.10	1.30
L3	2.80	3.00	3.20
θ	0°	4°	8°
e	2.285 BSC		



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Revision history

Major changes since the last revision

Revision	Date	Description of changes
1.0	2022-02-28	Initial release
2.0	2023-10-30	Enrich dynamic specification curves
3.0	2023-12-25	Update dynamic parameters